

AXI PRODUCT Portfolio

Automated X-ray Inspection



www.nordson.com/TestInspect

Nordson TEST & INSPECTION

Founded in 1954, Nordson Corporation is a market leading industrial technology company with annual revenues of over \$2.1 billion and more than 7,500 employees worldwide.

Nordson TEST & INSPECTION offers its SMT & Semiconductor customers a robust product portfolio, including Acoustic, Optical and both Manual and Automated X-ray Inspection systems, X-ray Component Counting systems and Semiconductor measurement sensors. Nordson TEST & INSPECTION is uniquely positioned to serve its customers with best-inclass precision technologies, passionate sales and support teams, global reach, and unmatched consultative applications expertise.

AXI Products

High Speed High Flexibility

Automated X-ray Inspection





MXI Products

Making the

Invisible, Visible

Manual

X-ray Inspection

AXM Products

Measuring the Invisible

> Automated X-ray Metrology





CC Products

Count On Us™

X-ray Component Counting





XRT Products

High Speed High Resolution

> X-ray Technologies



BT Products

Test Your Design

Bondtesters

Optical Inspection & Metrology







Exceptional support from Nordson's worldwide network



AOI Products

Proprietary Advanced Technology



WS Products

Improve Your Yields

Semiconductor Metrology Sensors



AMI Products

Qualify Your Design

Acoustic Inspection





XS-Series

High Resolution Automated X-ray

The XS-platform series is a small-footprint high-resolution automated X-ray inspection system concept designed for sophisticated high-speed inspection of semiconductor samples, wire bondsflip chips and PCBassembly boards for single/ multipanels or samples in trays. The inspectable applications range from component level inspection to mid-sized SMT boards.

Characteristics

- Ultra-High Resolution High speed AXI system with minimum footprint for inline setups
- Microfocus / submicron X-ray tube (sealed tube / maintenance free)
- Resolution down to <1 μm</p>
- Multiple programmable motion system with linear drives
- Digital CMOS flatpanel detector
- Automatic grey-scale and geometrical calibration
- Full product traceability via SECS/GEM and customized MES-Interface
- IPC-CFX and IPC-Hermes support





LED Wire-Sweep Solder Bondtest Joint Inspection

Flip Chip

Power Device Sensors Cooling Plates





Overlapping wires in 2D

Wire tracing

- and flex circuits

Technologies

- Dynamic Planar CT

Models

Additional options

Standard configurations

SMT setup for component and solder-joint inspection on PCB, hybrid or chip level assembly processes Ultra-High Resolution Semi-Backend setup for semiconductor applications, wire-bond test (pre & post), light & complex PCB's

Transmission X-ray imaging (2D) with patented Slice-Filter-Technique™ Off-axis technology (2.5D) 3D SART (Simultaneous Algebraic Reconstruction Technique)

Depending on the type of product & inspection task XS-2.5 Transmission (2D) + SFT[™] + Off-axis (2.5D) XS-3 Transmission (2D) + SFT[™] + Off-axis (2.5D) + 3D SART/DPCT

Same-side load/unload configuration Barcode scanner for serial number and product type selection Auto BCR scanning station (x-y gantry) Low dose radiation filter



Voiding under bonding ball

X-Series

High Speed Automated X-ray

The X-platform series is a dedicated high speed inline automated X-ray inspection system for the inspection of PCB-assembly boards for single/ multipanels or samples in trays. The system offers market leading inspection speed and is ideal for low-mix high-volume production environment.

Characteristics

- High speed AXI system for inline configurations
- Microfocus X-ray tube (sealed tube / maintenance free)
- Multiple programmable motion system with servo drives
- Digital CMOS flatpanel detector
- Automatic grey-scale and geometrical calibration
- Barcode scanner for serial number and product type selection
- Full product traceability via customized MES-Interface
- IPC-CFX and IPC-Hermes support

Highlights

- Hardware setup dedicated to PCB inspection
- High speed setup for inline pass through configuration

PTH

High oblique angle



SMT setup for component and solder-joint inspection on PCB, hybrid or chip level assembly processes

Technologies

- Dynamic Planar CT

Models

Additional options

- Low dose radiation filter



Solder Power Joint Devices Inspection Cooling Plates





BGA HiP in 2.5D

PTH inspection

Standard configurations

- Transmission X-ray imaging (2D) with
- patented Slice-Filter-Technique™
- Off-axis technology (2.5D)
- 3D SART (Simultaneous Algebraic Reconstruction Technique)

Depending on the type of product & inspection task X2 Transmission (2D) + SFT[™] X2.5 Transmission (2D) + SFT[™] + Off-axis (2.5D) X3 Transmission (2D) + SFT[™] + Off-axis (2.5D) + 3D SART/DPCT

Barcode scanner for serial number and product type selection Auto BCR scanning station (x-y gantry)

X#-Series

Flexible, Automated X-ray

The X#-platform series is an inline automated X-ray system which covers a wide range of AXI applications. It is a flexible platform with very versatile fields of use depending on the application requirements. The inspectable applications range from component level inspection, large SMT boards, high-power electronic modules, IGBTs up to fully assembled modules.

Characteristics

LED

- Flexible AXI system for inline and island of automation configurations
- Microfocus X-ray tube (sealed tube / maintenance free)
- Multiple programmable motion system with servo drives
- Digital CMOS flatpanel detector
- Automatic grey-scale and geometrical calibration
- Barcode scanner for serial number and product type selection
- Full product traceability via customized SECS/GEM and MES-Interface

Sensors

Solder

Joint

Inspection

■ IPC-CFX and IPC-Hermes support

Component

Test





Power Device

Cooling

Plates

PTH

Subassenblies

(automotive)

Finaly **Batteries** Assebly Test (Consumer)





Models



Standard configurations

SMT setup for component and solder-joint inspection on PCB Final Assembly and Test (FATP) setup for complete modules and consumer products

Ultra-High Power setup for power hybrid/IGBT devices and battery

Technologies

Transmission X-ray imaging (2D) with patented Slice-Filter-Technique™ Off-axis technology (2.5D) 3D SART (Simultaneous Algebraic Reconstruction Technique) Dynamic Planar CT

Depending on the type of product & inspection task X2# Transmission (2D) + SFT[™] X2.5# Transmission (2D) + SFT[™] + Off-axis (2.5D) X3# Transmission (2D) + SFT[™] + Off-axis (2.5D) + 3D SART

Additional options

Flexible setup for inline pass through or same-side in/out configuration Combination with line scan camera for high throughput Auto BCR scanning station (x-y gantry) Low dose radiation filter



Multi layer void inspection (IGBT)

Final product inspection

Technologies

MIPS Software Suite

2D - Transmission

High speed inspection technique with up-to 5-6 images/sec. and with best high-resolution capability. Transmission is two-dimensional image capturing with a fixed detector position. Movable sample tray and movable X-ray tube for different magnifications.

SFT[™] - Slice Filter Technique

Nordson's patented inspection technique to separate top and bottom side for doublesided PCB-assembly applications. High speed technique using first side image to filter out from double-side image.

2.5D - Off-axis

AXI on programmable angle-shots up to 60 dgr(used for high performance BGA and PTH inspection).

3D - SART

3D-Tomosynthesis to generate multiple horizontal slices used for high-dense doublesided and multi-chip-modules (e.g.: MCM,LGA).

Line Scan

Fastest inspection technique using continuous scan via line scan detector to generate a large area X-ray image.





The MIPS software suite provides a complete and overall solution for a wide variety of X-ray applications.

MIPS software lineup contains specific components for different tasks from the very beginning of the inspection process (CAD creation and import) to the very end (statistical data analysis). This approach leads to a flexible and effective software environment which aligns perfectly with the outstanding capabilities of the Nordson's AXI product portfolio.

Highlights

- Modular and easy-to-handle software environment for quick program generation and new product introduction both on-the-fly and offline
- Unique and automated calibration procedures ensuring machine-to-machine program portability and a working global library structure
- Highly customizable algorithm library for full defect coverage and minimal false calls rate
- Full palette and combination of inspection techniques from simple transmission imaging to highly complex inline and offline 3D inspection



MIPS Verify - Defect verification and repair suite



MIPS DPMO - Statistical software tool



- Comprehensive statistical tools for process control and feedback, but also for good/bad sorting optimization
- Smart factory integration through comprehensive and customized traceability implementation
- Closed loop communication between inspection, verification, repair and fine-tuning process
- Custom solutions for handling, bad-part sorting and marking
- Operator training tools to grant audit save end-of-line decisions



MIPS Verify trainer

Accessories

When using a programmable bar code scanning station the system can adjust the position of the scan avoiding the need to change the position of the rigidly mounted scanners. This increases the flexibility especially for pallet changes with different products. The system is no longer limited by the speed that the bar code reader can recognize the bar codes and therefore the input speed can be increased turning out in a higher throughput.

BCR-1000

Handling option for the X#-series

The BCR-1000 is an upgrade kit to the standard input conveyor for the X#-series systems that allows automated scanning of product bar codes.





BCR-1100

Handling option for the XS-series The BCR-1000 is a standalone barcode reader station with a multi-position barcode reading capability and clean room grade gantry solution.





For more information, speak with your Nordson representative or contact your Nordson regional office

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